ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration of	ion of the su	ubstances s all lowe	within the ma r level materia	nufacturer als for whic	listed item. Neh the manufac	ote: if th cturer ha	e item is an as s engineering	sembly with lower responsibility.
	-21.1 IPC Web Site for Information on IPC-1752 Standard Form Distribution Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					s and Mfg Information				
Supplier Information														
Company name* Cor			Company unique ID			Unique ID Authority					Response Date*			
onsemi										2	2024-05-10			
Contact Name	ontact Name Title - Contact					Phone - Contact*					Email - Contact*			
Product-Env-Stewards Product 1			duct Enviro Compliance			NA				1	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Re			- Representative			Phone - Representative*				E	Email - Representative*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA				1	Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight	t*	UOM	Unit Type
	SZESD7	SZESD7371P2T5G low cap ESE		D in SOD-923		2024-05-10			CN1		0.442		mg	Each
Manufacturing Proccess Informa	tion												·	
Terminal Plating / Grid Array M	Material Terminal Base Alloy		Alloy	J-STD-020 MSI	TD-020 MSL Rating		Peak Process Body Temperature		re Max Time at Peak Tempera		emperature N	nperature Number of Reflow Cycles		les
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		seconds 3	3		
Comments														
evel 1 - maximum time at peak temperatu	ire during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg	
Lead Frame	0.21	mg	Supplier	Silver (Ag)	7440-22-4		0.0374	mg	
			В	Nickel (Ni)	7440-02-0		0.0649	mg	
			Supplier	Iron (Fe)	7439-89-6		0.0897	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0181	mg	
Mold Compound-Black	0.19	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.019	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0009	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0275	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.1235	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.019	mg	
Plating	0.01	mg	Supplier	Tin (Sn)	7440-31-5		0.01	mg	
Wire Bond - Au	0.002	mg	Supplier	Gold (Au)	7440-57-5		0.002	mg	